MIC3775

750 mA µCap Low Voltage, Low Dropout Regulator

Features

- Fixed and Adjustable Output Voltages to 1.24V
- 280 mV Typical Dropout at 750 mA
  - Ideal for 3.0V to 2.5V Conversion
  - Ideal for 2.5V to 1.8V or 1.65V Conversion
- Stable with Ceramic Capacitor
- 750 mA Minimum Guaranteed Output Current
- 1% Initial Accuracy
- Low Ground Current
- Current Limiting and Thermal Shutdown
- Reversed-Leakage Protection
- Fast Transient Response
- Low Profile Power MSOP-8 Package

Applications

- Fiber Optic Modules
- LDO Linear Regulator for PC Add-In Cards
- PowerPC Power Supplies
- High-Efficiency Linear Power Supplies
- SMPS Post Regulator
- Multimedia and PC Processor Supplies
- Battery Chargers
- Low-Voltage Microcontrollers and Digital Logic

General Description

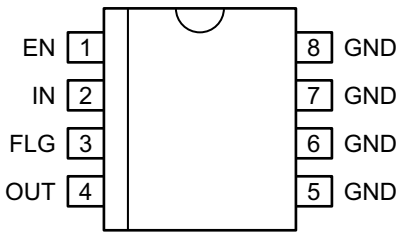
The MIC3775 is a 750 mA low dropout linear voltage regulators that provides low voltage, high current output from an extremely small package. Utilizing Microchip's proprietary Superβeta PNP pass element, the MIC3775 offers extremely low dropout (typically 280 mV at 750 mA) and low ground current (typically 7.5 mA at 750 mA).

The MIC3775 is ideal for PC add-in cards that need to convert from standard 5V to 3.3V or 3.0V, 3.3V to 2.5V, or 2.5V to 1.8V or 1.65V. A guaranteed maximum dropout voltage of 500 mV over all operating conditions allows the MIC3775 to provide 2.5V from a supply as low as 3.0V and 1.8V or 1.5V from a supply as low as 2.25V.

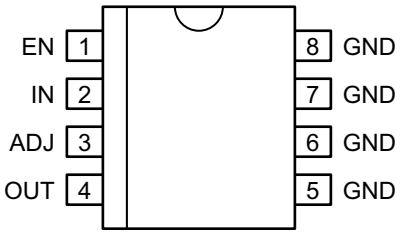
The MIC3775 is fully protected with overcurrent limiting, thermal shutdown, and reversed-leakage protection. Fixed and adjustable output voltage options are available with an operating temperature range of –40°C to +125°C.

Package Types

MIC3775 (FIXED)
MSOP-8 (MM)
(Top View)



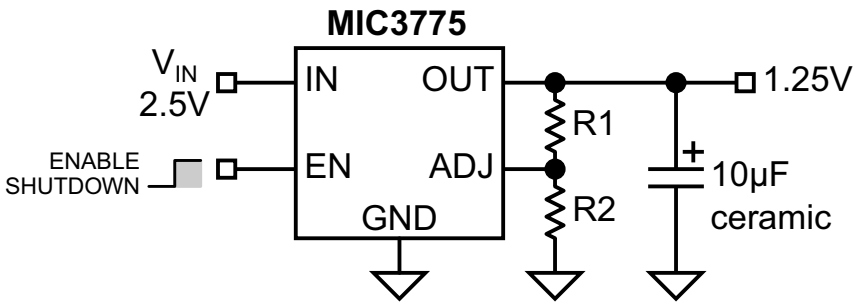
MIC3775 (ADJ)
MSOP-8 (MM)
(Top View)



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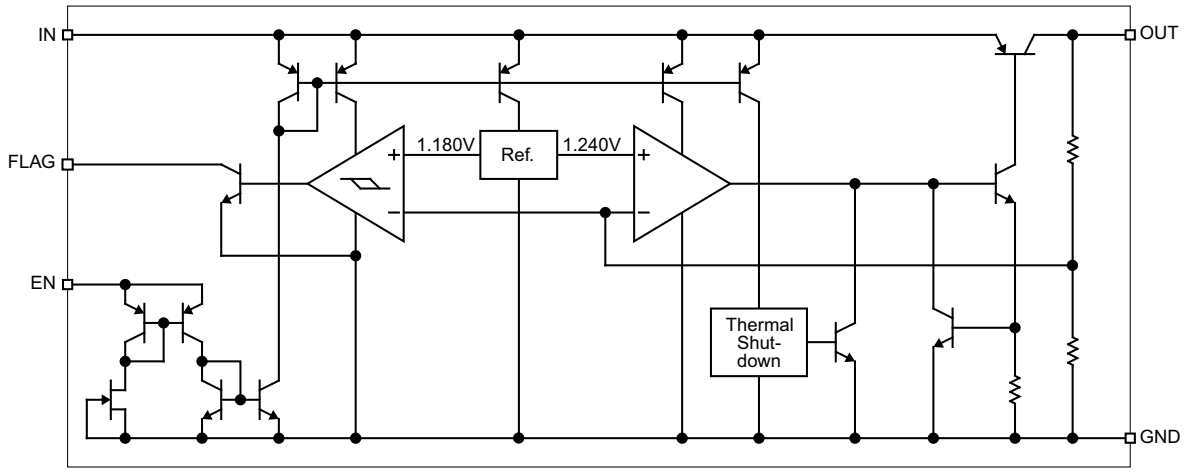
Typical Application Circuit

1.25V/750 mA Adjustable Regulator

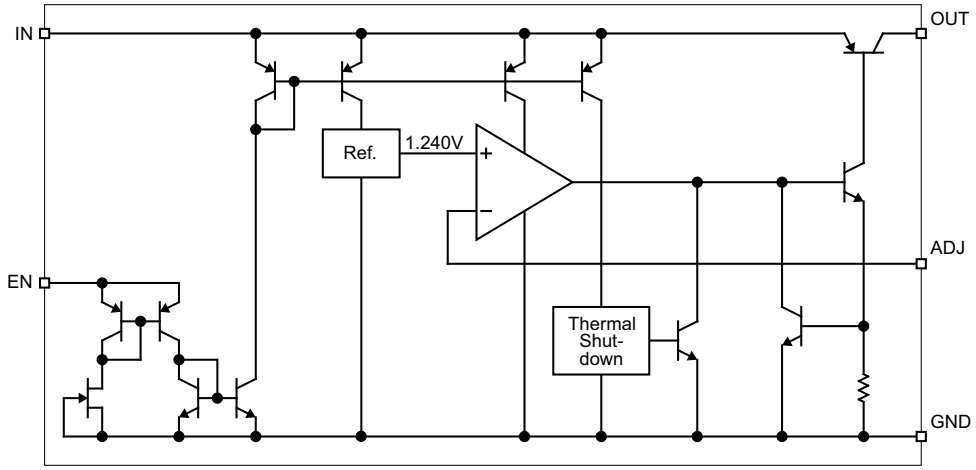


Functional Block Diagrams

MIC3775 Fixed Regulator with Flag and Enable



MIC3775 Adjustable Regulator



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1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Supply Voltage (V_{IN}) ..... +6.5V
Enable Voltage (V_{EN}) ..... +6.5V
Lead Temperature (Soldering, 5 sec.) ..... +260°C
Storage Temperature (T_S) ..... –65°C to +150°C
ESD Rating ..... Note 1

Operating Ratings ††

Supply Voltage (V_{IN}) ..... +2.25V to +6V
Enable Voltage (V_{EN}) ..... 0V to +6V
Maximum Power Dissipation ($P_{D(MAX)}$) ..... Note 2
Junction Temperature (T_J) ..... –40°C to +125°C
Package Thermal Resistance (MSOP-8, θ_{JA}) ..... 80°C/W

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

†† **Notice:** The device is not guaranteed to function outside its operating ratings.

Note 1: Devices are ESD sensitive. Handling precautions are recommended. Human body model, 1.5 kΩ in series with 100 pF.

2: $P_{D(MAX)} = (T_{J(MAX)} – T_A) \div \theta_{JA}$, where θ_{JA} depends upon the printed circuit layout. See “Applications Information.”

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: $V_{IN} = V_{OUT} + 1V$; $V_{EN} = 2.25V$; $T_J = +25°C$, **bold** values indicate $–40°C \le T_J \le +125°C$, unless noted. Note 1

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Output Voltage	V_{OUT}	–1	—	1	%	10 mA
		–2	—	**2**		10 mA ≤ I_{OUT} ≤ 750 mA, $V_{OUT} + 1V \le V_{IN} \le 6V$
Line Regulation	$\Delta V_{OUT}/V_{OUT}$	—	0.06	0.5	%	I_{OUT} = 10 mA, $V_{OUT} + 1V \le V_{IN} \le 6V$
Load Regulation	$\Delta V_{OUT}/V_{OUT}$	—	0.2	1	%	$V_{IN} = V_{OUT} + 1V$, 10 mA ≤ I_{OUT} ≤ 750 mA
Output Voltage Temp. Coefficient	$\Delta V_{OUT}/\Delta T$	—	40	—	ppm/°C	Note 2
Dropout Voltage (Note 3)	V_{DO}	—	125	200	mV	I_{OUT} = 100 mA
		—	—	**250**		
		—	210	—		I_{OUT} = 500 mA
		—	280	**500**		I_{OUT} = 750 mA

Note 1: Specification for packaged product only.

2: Output voltage temperature coefficient is $\Delta V_{OUT(WORSTCASE)} \div (T_{J(MAX)} – T_{J(MIN)})$ where $T_{J(MAX)}$ is +125°C and $T_{J(MIN)}$ is –40°C.

3: $V_{DO} = V_{IN} – V_{OUT}$ when V_{OUT} decreases to 98% of its nominal output voltage with $V_{IN} = V_{OUT} + 1V$. For output voltages below 1.75V, dropout voltage is the input-to-output voltage differential with the minimum input voltage being 2.25V. Minimum input operating voltage is 2.25V.

4: I_{GND} is the quiescent current. $I_{IN} = I_{GND} + I_{OUT}$.

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: $V_{IN} = V_{OUT} + 1V$; $V_{EN} = 2.25V$; $T_J = +25°C$, **bold** values indicate $–40°C \le T_J \le +125°C$, unless noted. Note 1

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Ground Current (Note 4)	I_{GND}	—	700	—	µA	I_{OUT} = 100 mA, $V_{IN} = V_{OUT} + 1V$
		—	3.7	—	mA	I_{OUT} = 500 mA, $V_{IN} = V_{OUT} + 1V$
		—	7.5	**15**		I_{OUT} = 750 mA, $V_{IN} = V_{OUT} + 1V$
Current Limit	$I_{OUT(LIM)}$	—	1.6	2.5	A	V_{OUT} = 0V, $V_{IN} = V_{OUT} + 1V$
Enable Input						
Enable Input Voltage	V_{EN}	—	—	**0.8**	V	Logic low (off)
		2.25	—	—		Logic high (on)
Enable Input Current	I_{EN}	1	10	**30**	µA	V_{EN} = 2.25V
		—	—	2		V_{EN} = 0.8V
		—	—	**4**		
Flag Output						
Output Leakage Current	$I_{FLG(LEAK)}$	—	0.01	1	µA	V_{OH} = 6V
		—	—	**2**		
Output Low Voltage	$V_{FLG(DO)}$	—	250	**500**	mV	V_{IN} = 2.250V, I_{OL} = 250 µA
Low Threshold	V_{FLG}	93	—	—	%	% of V_{OUT}
High Threshold		—	—	99.2		% of V_{OUT}
Hysteresis		—	1	—		—
Adjustable Output Only						
Reference Voltage	V_{REF}	1.227	1.240	1.252	V	—
		1.215	—	**1.265**		
Adjust Pin Bias Current	—	—	40	80	nA	—
		—	—	**120**		

Note 1: Specification for packaged product only.

2: Output voltage temperature coefficient is $\Delta V_{OUT(WORSTCASE)} \div (T_{J(MAX)} – T_{J(MIN)})$ where $T_{J(MAX)}$ is +125°C and $T_{J(MIN)}$ is –40°C.

3: $V_{DO} = V_{IN} – V_{OUT}$ when V_{OUT} decreases to 98% of its nominal output voltage with $V_{IN} = V_{OUT} + 1V$. For output voltages below 1.75V, dropout voltage is the input-to-output voltage differential with the minimum input voltage being 2.25V. Minimum input operating voltage is 2.25V.

4: I_{GND} is the quiescent current. $I_{IN} = I_{GND} + I_{OUT}$.

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TEMPERATURE SPECIFICATIONS

Parameters	Sym.	Min.	Typ.	Max.	Units	Conditions
Temperature Ranges						
Maximum Junction Temperature Range	T_J	–40	—	+125	°C	—
Storage Temperature Range	T_S	–65	—	+150	°C	—
Lead Temperature	—	—	—	+260	°C	Soldering, 5 sec.
Package Thermal Resistances						
Thermal Resistance, MSOP 8-Ld	θ_{JA}	—	80	—	°C/W	—

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

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2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

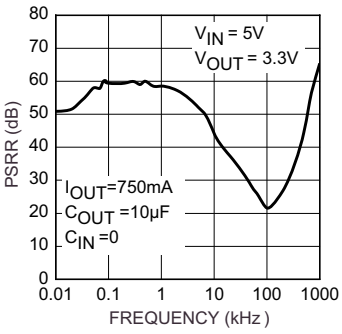


FIGURE 2-1: *Power Supply Rejection Ratio.*

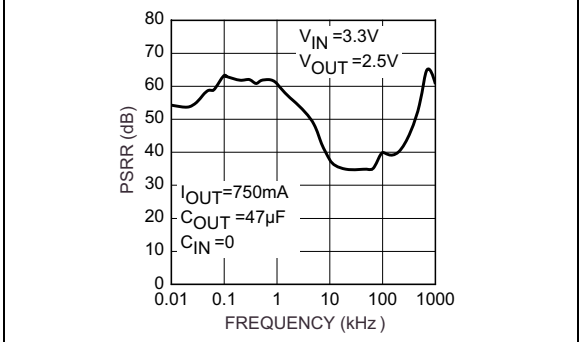


FIGURE 2-4: *Power Supply Rejection Ratio.*

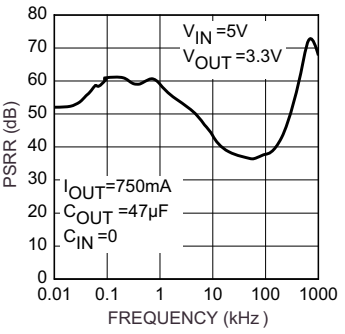


FIGURE 2-2: *Power Supply Rejection Ratio.*

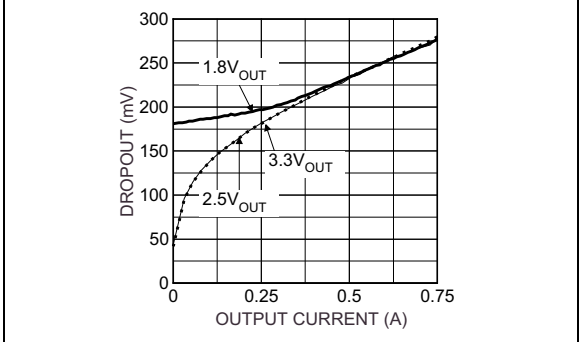


FIGURE 2-5: *Dropout vs. Output Current.*

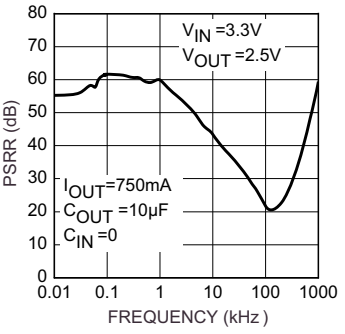


FIGURE 2-3: *Power Supply Rejection Ratio.*

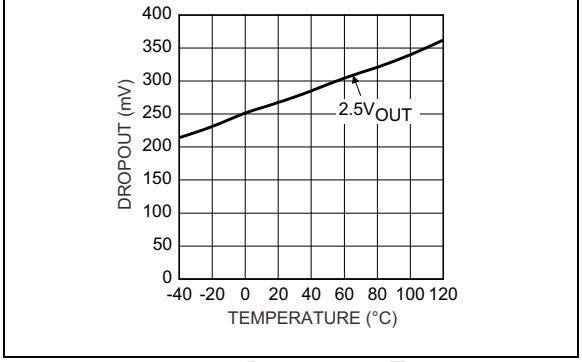


FIGURE 2-6: *Dropout vs. Temperature.*

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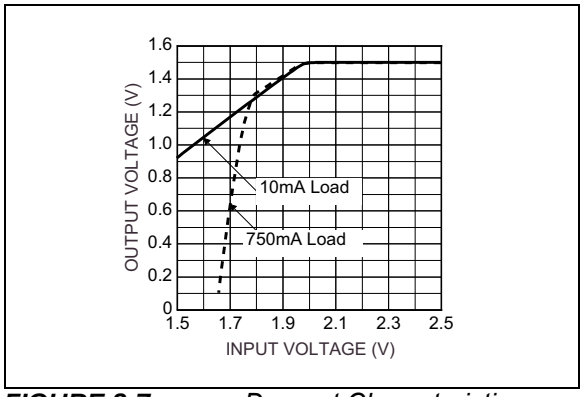


FIGURE 2-7: *Dropout Characteristics (1.5V).*

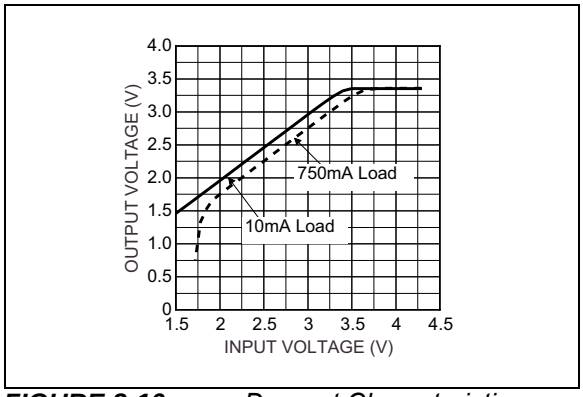


FIGURE 2-10: *Dropout Characteristics (3.3V).*

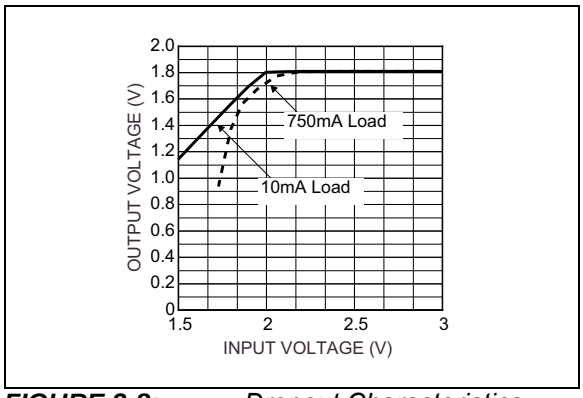


FIGURE 2-8: *Dropout Characteristics (1.8V).*

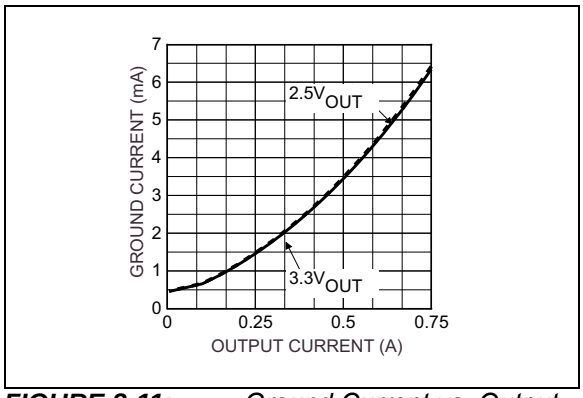


FIGURE 2-11: *Ground Current vs. Output Current.*

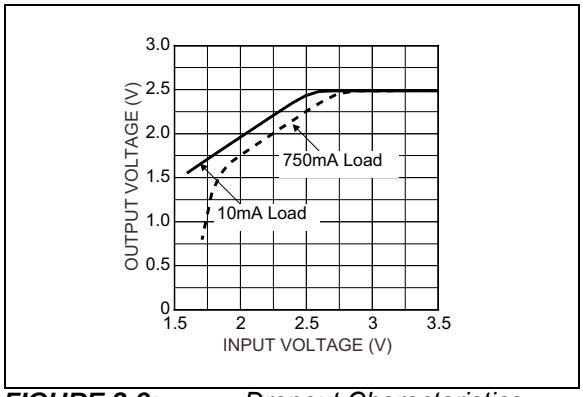


FIGURE 2-9: *Dropout Characteristics (2.5V).*

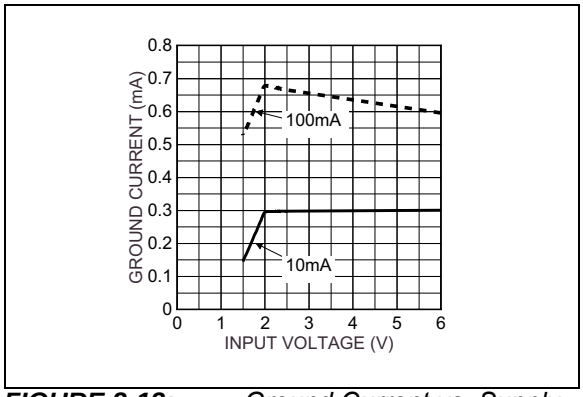


FIGURE 2-12: *Ground Current vs. Supply Voltage (1.5V).*

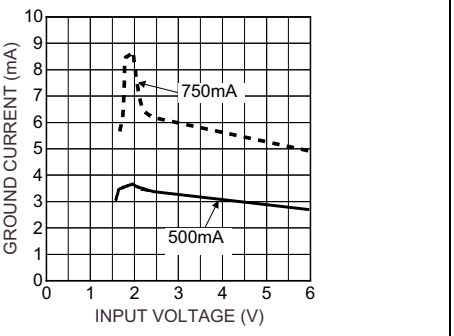


FIGURE 2-13: *Ground Current vs. Supply Voltage (1.5V).*

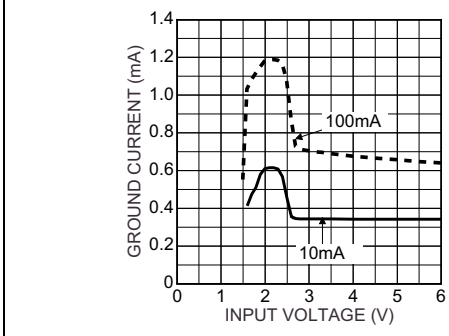


FIGURE 2-16: *Ground Current vs. Supply Voltage (2.5V).*

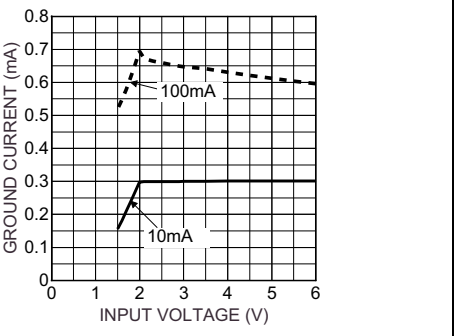


FIGURE 2-14: *Ground Current vs. Supply Voltage (1.8V).*

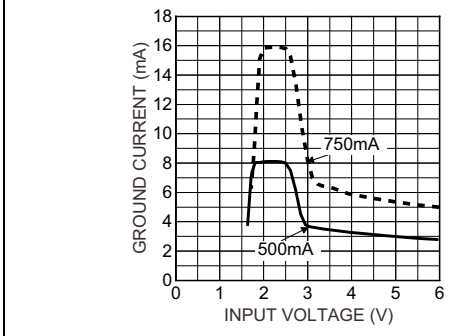


FIGURE 2-17: *Ground Current vs. Supply Voltage (2.5V).*

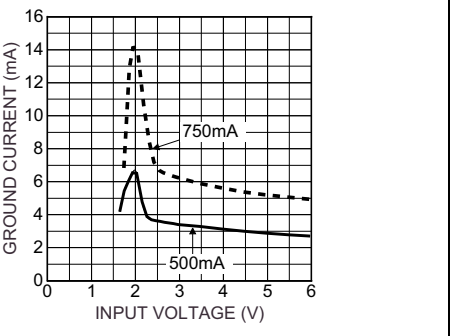


FIGURE 2-15: *Ground Current vs. Supply Voltage (1.8V).*

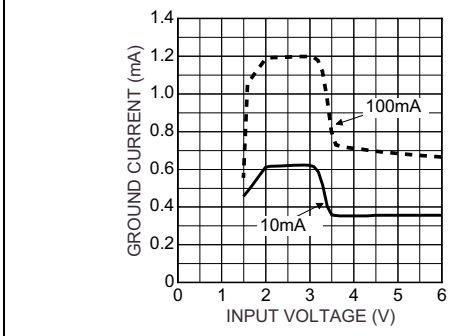


FIGURE 2-18: *Ground Current vs. Supply Voltage (3.3V).*

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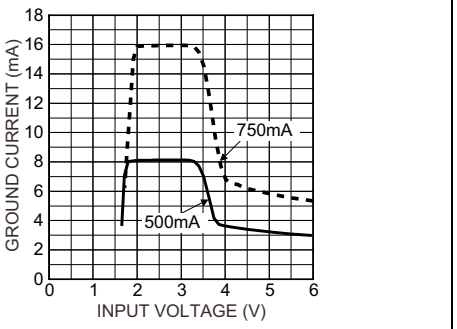


FIGURE 2-19: *Ground Current vs. Supply Voltage (3.3V).*

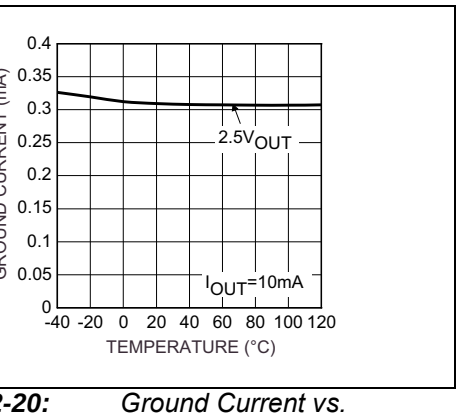


FIGURE 2-20: *Ground Current vs. Temperature.*

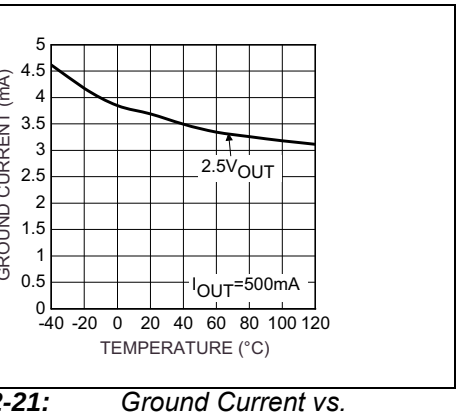


FIGURE 2-21: *Ground Current vs. Temperature.*

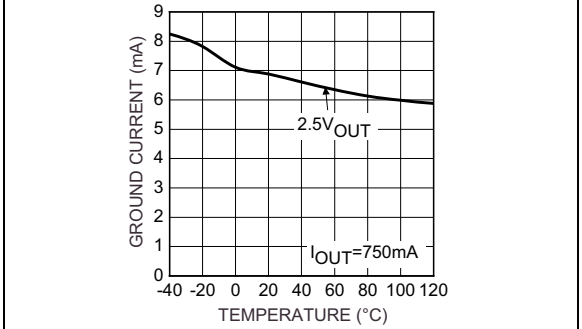


FIGURE 2-22: *Ground Current vs. Temperature.*

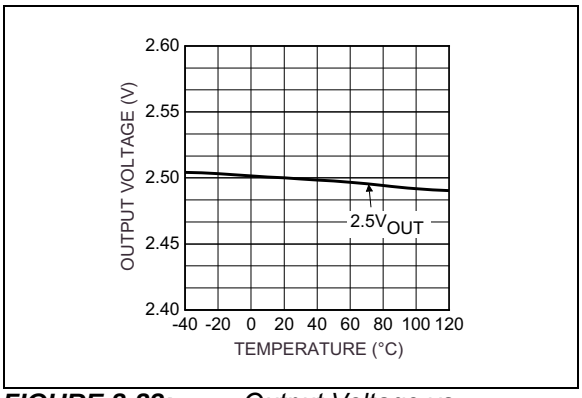


FIGURE 2-23: *Output Voltage vs. Temperature.*

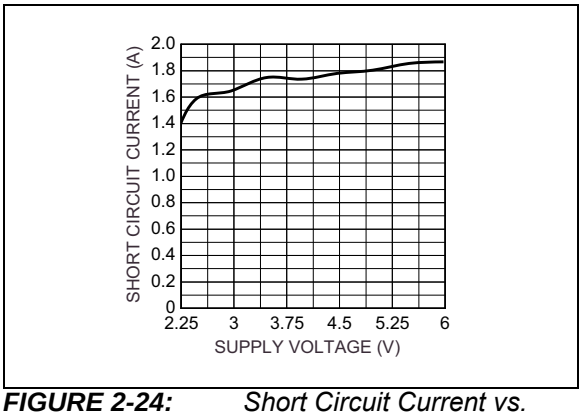


FIGURE 2-24: *Short Circuit Current vs. Supply Voltage.*

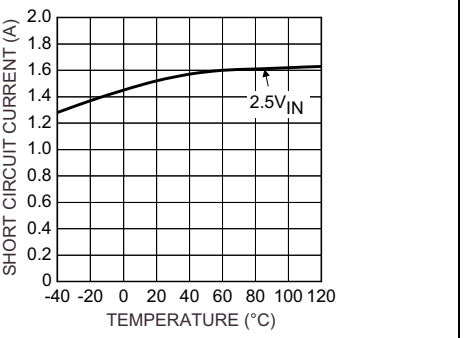


FIGURE 2-25: *Short Circuit Current vs. Temperature.*

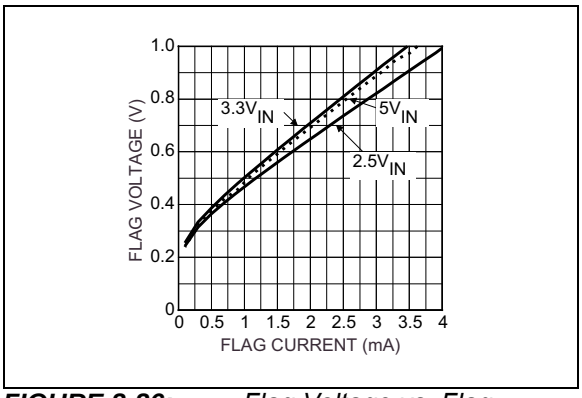


FIGURE 2-26: *Flag Voltage vs. Flag Current.*

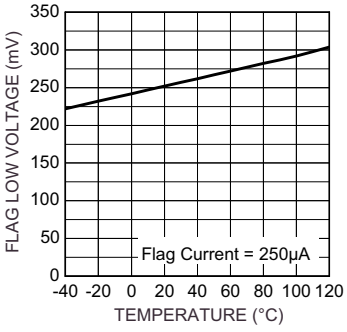


FIGURE 2-27: *Flag Low Voltage vs. Temperature.*

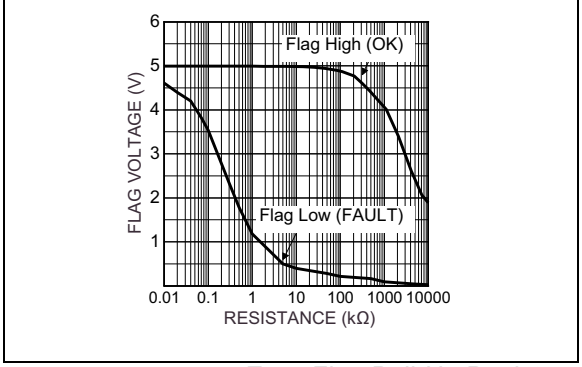


FIGURE 2-28: *Error Flag Pull-Up Resistor.*

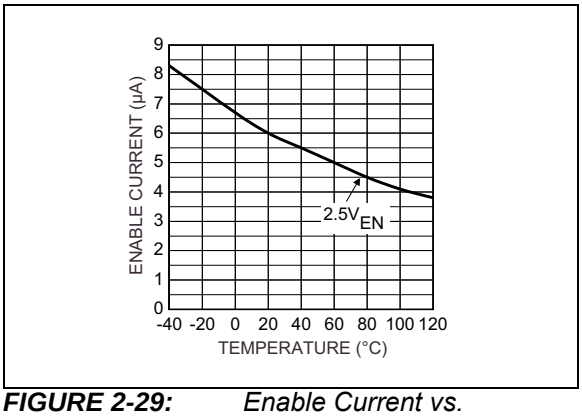


FIGURE 2-29: *Enable Current vs. Temperature.*

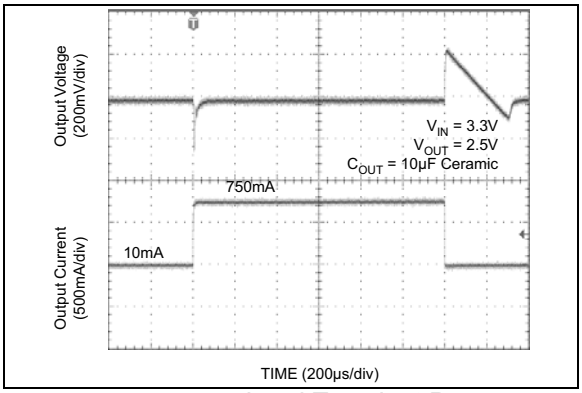


FIGURE 2-30: *Load Transient Response.*

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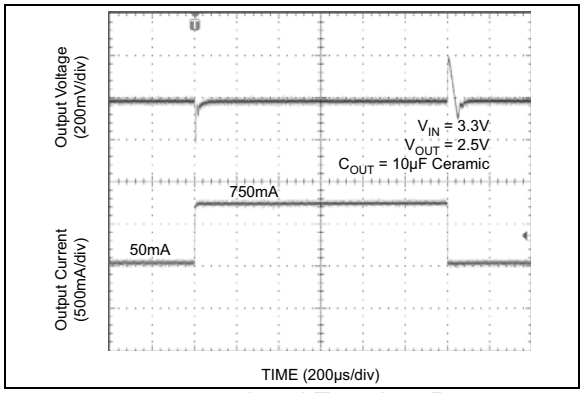


FIGURE 2-31: *Load Transient Response.*

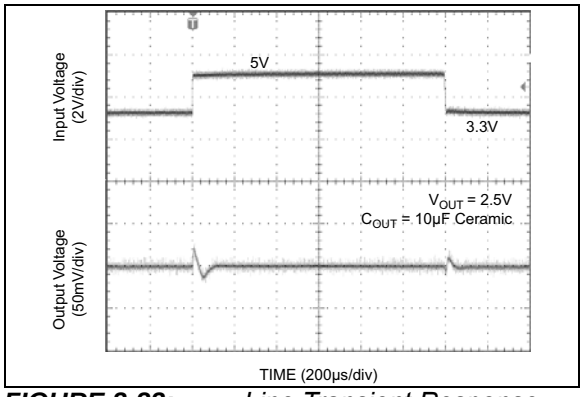


FIGURE 2-32: *Line Transient Response.*

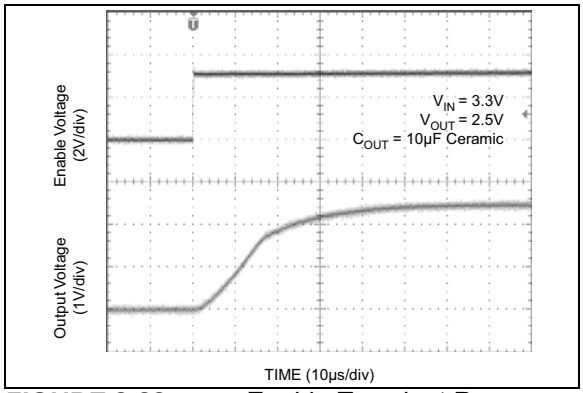


FIGURE 2-33: *Enable Transient Response.*

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	EN	Enable (Input): CMOS-compatible control input. Logic high = enable, logic low or open = shutdown. Do not leave this pin floating.
2	IN	Supply (Input).
3	FLG	Flag (Output): Open-collector error flag output. Active low = output undervoltage.
	ADJ	Adjustment Input: Feedback input. Connect to resistive voltage-divider network.
4	OUT	Regulator Output.
5 - 8	GND	Ground.

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4.0 APPLICATION INFORMATION

The MIC3775 is a high-performance low-dropout voltage regulator suitable for moderate to high-current voltage regulator applications. Its 500 mV dropout voltage at full load and over temperature makes it especially valuable in battery-powered systems and as high-efficiency noise filters in post-regulator applications. Unlike older NPN-pass transistor designs, where the minimum dropout voltage is limited by the base-to-emitter voltage drop and collector-to-emitter saturation voltage, dropout performance of the PNP output of these devices is limited only by the low V_{CE} saturation voltage.

A trade-off for the low-dropout voltage is a varying base drive requirement. Microchip's Superβeta PNP process reduces this drive requirement to only 2% of the load current.

The MIC3775 regulator is fully protected from damage due to fault conditions. Linear current limiting is provided. Output current during overload conditions is constant. Thermal shutdown disables the device when the die temperature exceeds the maximum safe operating temperature. The output structure of these regulators allows voltages in excess of the desired output voltage to be applied without reverse current flow.

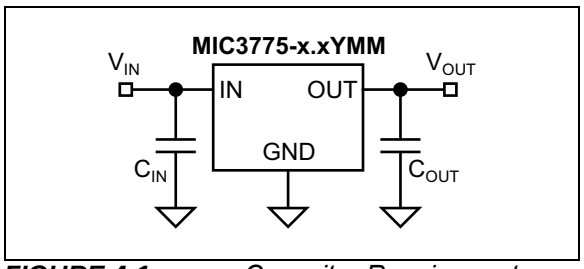


FIGURE 4-1: *Capacitor Requirements.*

4.1 Output Capacitor

The MIC3775 requires an output capacitor for stable operation. As a µCap LDO, the MIC3775 can operate with ceramic output capacitors as long as the amount of capacitance is 10 µF or greater. For values of output capacitance lower than 10 µF, the recommended ESR range is 200 mΩ to 2Ω. The minimum value of output capacitance recommended for the MIC3775 is 4.7 µF.

For 10 µF or greater, the ESR range recommended is less than 1Ω. Ultra-low ESR ceramic capacitors are recommended for output capacitance of 10 µF or greater to help improve transient response and noise reduction at high frequency. X7R/X5R dielectric-type ceramic capacitors are recommended because of their temperature performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60% respectively over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

4.2 Input Capacitor

An input capacitor of 1 µF or greater is recommended when the device is more than 4 inches away from the bulk AC supply capacitance or when the supply is a battery. Small, surface mount, ceramic chip capacitors can be used for bypassing. Larger values will help to improve ripple rejection by bypassing the input to the regulator, further improving the integrity of the output voltage.

4.3 Error Flag

The MIC3775 features an error flag (FLG) that monitors the output voltage and signals an error condition when this voltage drops 5% below its expected value. The error flag is an open-collector output that pulls low under fault conditions and may sink up to 10 mA. Low output voltage signifies a number of possible problems, including an overcurrent fault (the device is in current limit) or low input voltage. The flag output is inoperative during overtemperature conditions. A pull-up resistor from FLG to either V_{IN} or V_{OUT} is required for proper operation. For information regarding the minimum and maximum values of pull-up resistance, refer to the graph in the Typical Performance Curves section of the data sheet.

4.4 Enable Input

The MIC3775 features an active-high enable input (EN) that allows on-off control of the regulator. Current drain reduces to "zero" when the device is shutdown, with only microamperes of leakage current. The EN input has TTL/CMOS compatible thresholds for simple logic interfacing. EN may be directly tied to V_{IN} and pulled up to the maximum supply voltage. Do not leave the Enable input pin floating.

4.5 Transient Response and 3.3V to 2.5V or 2.5V to 1.8V or 1.65V Conversion

The MIC3775 has excellent transient response to variations in input voltage and load current. The device has been designed to respond quickly to load current variations and input voltage variations. Large output capacitors are not required to obtain this performance. A standard 10 µF output capacitor is all that is required. Larger values help to improve performance even further.

By virtue of its low dropout voltage, this device does not saturate into dropout as readily as similar NPN-based designs. When converting from 3.3V to 2.5V or 2.5V to 1.8V or 1.65V, the NPN-based regulators are already operating in dropout, with typical dropout requirements of 1.2V or greater. To convert down to 2.5V or 1.8V without operating in dropout, NPN-based regulators require an input voltage of 3.7V at the very least. The MIC3775 regulator will provide excellent performance with an input as low as 3.0V or 2.5V respectively. This gives the PNP-based regulators a distinct advantage over older, NPN-based linear regulators.

4.6 Minimum Load Current

The MIC3775 regulator is specified between finite loads. If the output current is too small, leakage currents dominate and the output voltage rises. A 10 mA minimum load current is necessary for proper regulation.

4.7 Adjustable Regulator Design

The MIC3775 allows programming the output voltage anywhere between 1.24V and the 6V maximum operating rating of the family. Two resistors are used. Resistors can be quite large, up to 1 MΩ, because of the very high input impedance and low bias current of the sense comparator.

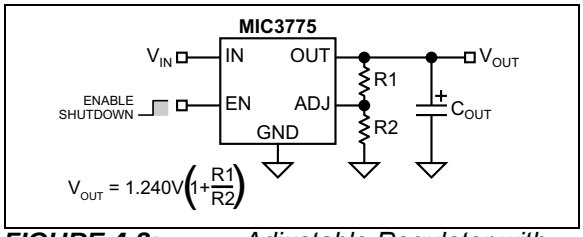


FIGURE 4-2: *Adjustable Regulator with Resistors.*

The resistor values are calculated by:

EQUATION 4-1:

$$R1 = R2\left(\frac{V_{OUT}}{1.240} - 1\right)$$

Where:
V_{OUT} = The desired output voltage.

Figure 4-2 shows component definition. Applications with widely varying load currents may scale the resistors to draw the minimum load current required for proper operation.

4.8 Power MSOP-8 Thermal Characteristics

One of the secrets of the MIC3775's performance is its power MSOP-8 package that features half the thermal resistance of a standard MSOP-8 package. Lower thermal resistance means more output current or higher input voltage for a given package size.

Lower thermal resistance is achieved by joining the four ground leads with the die attach paddle to create a single-piece electrical and thermal conductor. This concept has been used by MOSFET manufacturers for years, proving very reliable and cost effective for the user.

Thermal resistance consists of two main elements, θ_{JC} (junction-to-case thermal resistance) and θ_{CA} (case-to-ambient thermal resistance). See Figure 4-3. θ_{JC} is the resistance from the die to the leads of the package. θ_{CA} is the resistance from the leads to the ambient air and it includes θ_{CS} (case-to-sink thermal resistance) and θ_{SA} (sink-to-ambient thermal resistance).

Using the power MSOP-8 reduces the θ_{JC} dramatically and allows the user to reduce θ_{CA}. The total thermal resistance, θ_{JA} (junction-to-ambient thermal resistance) is the limiting factor in calculating the maximum power dissipation capability of the device. Typically, the power MSOP-8 has a θ_{JA} of 80°C/W, this is significantly lower than the standard MSOP-8, which is typically 160°C/W. θ_{CA} is reduced because pins 5 through 8 can now be soldered directly to a ground plane, which significantly reduces the case-to-sink thermal resistance and sink-to-ambient thermal resistance.

Low-dropout linear regulators from Microchip are rated to a maximum junction temperature of 125°C. It is important not to exceed this maximum junction temperature during operation of the device. To prevent this maximum junction temperature from being exceeded, the appropriate ground plane heat sink must be used.

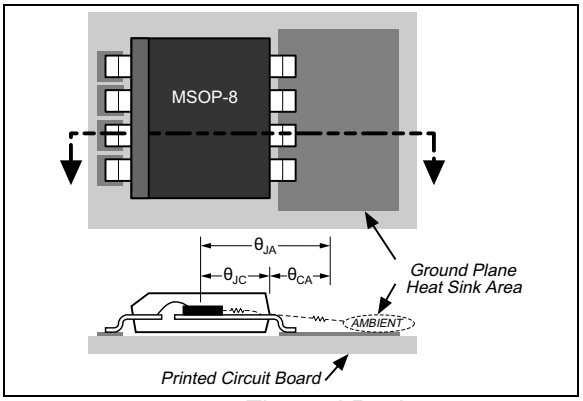


FIGURE 4-3: *Thermal Resistance.*

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Figure 4-4 shows copper area versus power dissipation with each trace corresponding to a different temperature rise above ambient.

From these curves, the minimum area of copper necessary for the part to operate safely can be determined. The maximum allowable temperature rise must be calculated to determine operation along which curve.

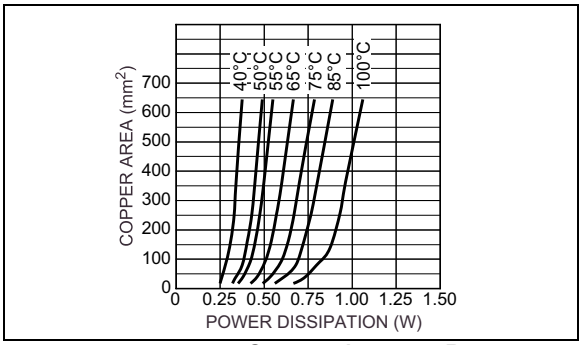


FIGURE 4-4: *Copper Area vs. Power MSOP Power Dissipation (ΔT_{JA}).*

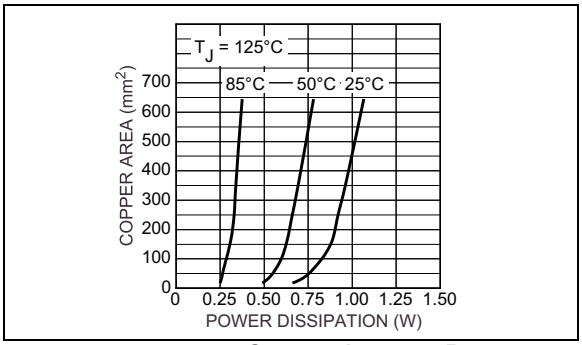


FIGURE 4-5: *Copper Area vs. Power MSOP Power Dissipation (T_A).*

EQUATION 4-2:

$$\Delta T = T_{J(MAX)} - T_{A(MAX)}$$

Where:
$T_{J(MAX)}$ = 125°C
$T_{A(MAX)}$ = The max. ambient operating temp.

For example, the maximum ambient temperature is 50°C, the ΔT is determined as follows:

EQUATION 4-3:

$$\Delta T = 125°C - 50°C = 75°C$$

Using Figure 4-4, the minimum amount of required copper can be determined based on the required power dissipation. Power dissipation in a linear regulator is calculated as follows:

EQUATION 4-4:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND}$$

If using a 2.5V output device and a 3.3V input at an output current of 750 mA, then calculating power dissipation is as follows:

EQUATION 4-5:

$$P_D = (3.3V - 2.5V) \times 750mA + 3.3V \times 7.5mA$$

$$P_D = 600mW + 25mW = 625mW$$

From Figure 4-4, the minimum amount of copper required to operate this application at a ΔT of 75°C is 160 mm^2.

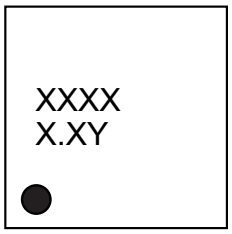
4.9 Quick Method

Determine the power dissipation requirements for the design along with the maximum ambient temperature at which the device will be operated. Refer to Figure 4-5, which shows safe operating curves for three different ambient temperatures: 25°C, 50°C, and 85°C. From these curves, the minimum amount of copper can be determined by knowing the maximum power dissipation required. If the maximum ambient temperature is 50°C and the power dissipation is 625 mW, the curve in Figure 4-5 shows that the required area of copper is 160 mm^2.The θ_{JA} of this package is ideally 80°C/W, but it will vary depending upon the availability of copper ground plane to which it is attached.

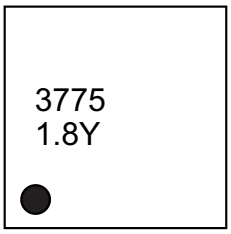
5.0 PACKAGING INFORMATION

5.1 Package Marking Information

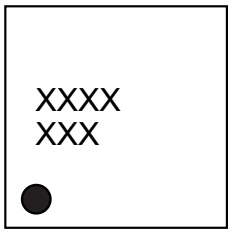
8-Lead MSOP*
(Fixed)



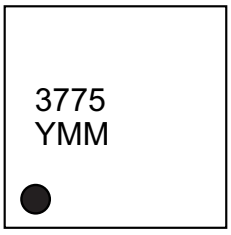
Example



8-Lead MSOP*
(Adj.)



Example



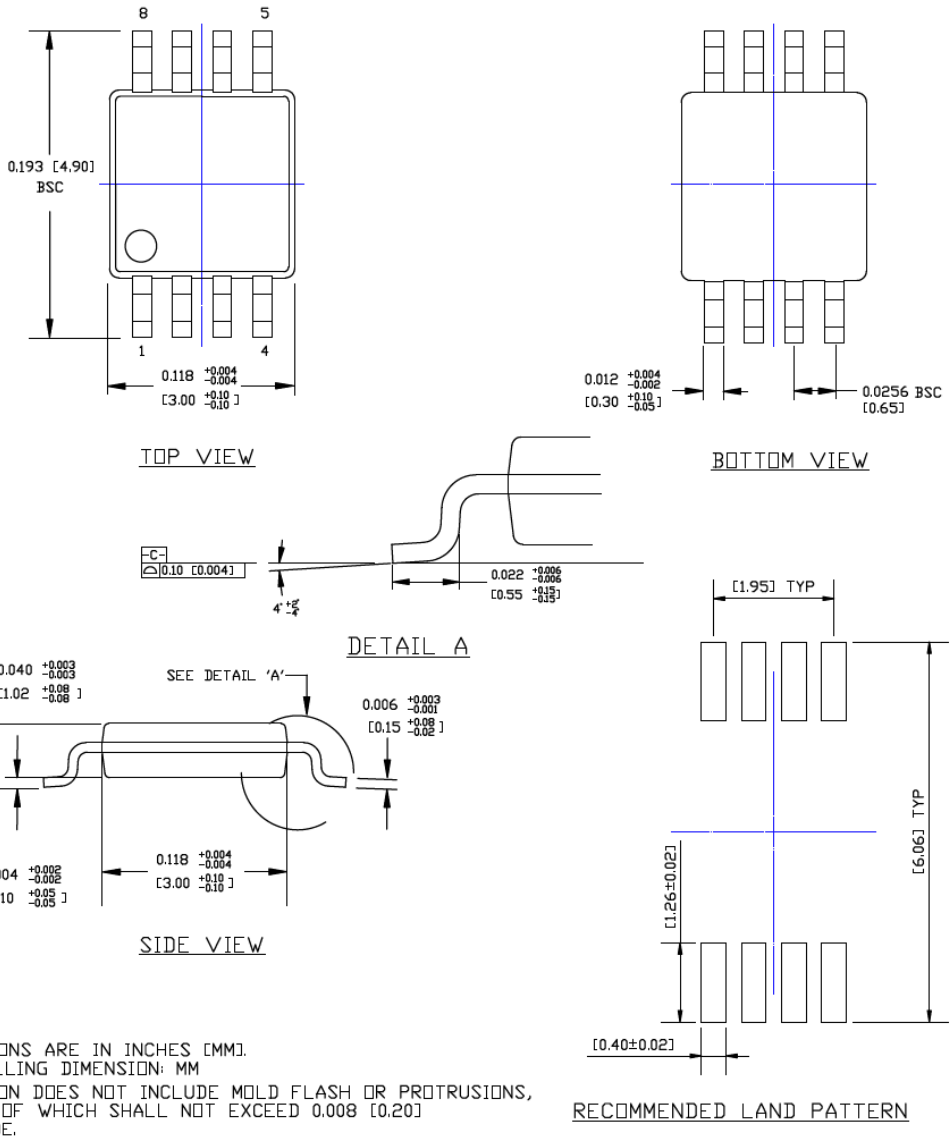
Legend:	XX...X	Product code or customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
	●, ▲, ▼	Pin one index is identified by a dot, delta up, or delta down (triangle mark).
Note:	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.	
	Underbar (_) and/or Overbar (¯) symbol may not be to scale.	

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8-Lead MSOP Package Outline & Recommended Land Pattern

TITLE
8 LEAD MSOP PACKAGE OUTLINE & RECOMMENDED LAND PATTERN

DRAWING #	MSOP-8LD-PL-1	UNIT	INCH [MM]



NOTES:
1. DIMENSIONS ARE IN INCHES [MM].
2. CONTROLLING DIMENSION: MM
3. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.008 [0.20] PER SIDE.

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging.

NOTES:

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APPENDIX A: REVISION HISTORY

Revision A (July 2018)

- Converted Micrel document MIC3775 to Microchip data sheet template DS20006045A.
- Minor grammatical text changes throughout.
- Typographical correction to the equation in Figure 4-2.

NOTES:

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PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

Device	-X.X	X	XX	-XX
Part No.	Output Voltage	Junction Temp. Range	Package	Media Type

Device:	MIC3775:	750 mA µCap Low Voltage, Low Dropout Regulator
Output Voltage:	1.5 =	1.5V
	1.65 =	1.65V
	1.8 =	1.8V
	2.5 =	2.5V
	3.0 =	3.0V
	3.3 =	3.3V
	<blank>=	Adjustable
Junction Temperature Range:	Y =	–40°C to +125°C, RoHS-Compliant
Package:	MM =	8-Lead MSOP
Media Type:	<blank>=	100/Tube
	TR =	2,500/Reel

Examples:

a) MIC3775-1.5YMM-TR: MIC3775, 1.5V Output Voltage, –40°C to +125°C Temperature Range, 8-Lead MSOP, 2,500/Reel

b) MIC3775-1.65YMM: MIC3775, 1.65V Output Voltage, –40°C to +125°C Temperature Range, 8-Lead MSOP, 100/Tube

c) MIC3775-1.8YMM-TR: MIC3775, 1.8V Output Voltage, –40°C to +125°C Temperature Range, 8-Lead MSOP, 2,500/Reel

d) MIC3775-2.5YMM: MIC3775, 2.5V Output Voltage, –40°C to +125°C Temperature Range, 8-Lead MSOP, 100/Tube

e) MIC3775-3.0YMM-TR: MIC3775, 3.0V Output Voltage, –40°C to +125°C Temperature Range, 8-Lead MSOP, 2,500/Reel

f) MIC3775-3.3YMM: MIC3775, 3.3V Output Voltage, –40°C to +125°C Temperature Range, 8-Lead MSOP, 100/Tube

g) MIC3775YMM-TR: MIC3775, Adjustable Output Voltage, –40°C to +125°C Temperature Range, 8-Lead MSOP, 2,500/Reel

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

NOTES:

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